

Field-Programmable Gate Array, 3584 Cell, 676 Pin, Plastic, BGA FPGA

Manufacturers	<a href="#">AMD Xilinx, Inc</a>
Package/Case	BGA676
Product Type	Programmable Logic ICs
RoHS	
Lifecycle	



Images are for reference only

Please submit RFQ for XC2V3000-4FG676I or [Email to us: sales@ovaga.com](mailto:sales@ovaga.com) We will contact you in 12 hours.

[RFQ](#)

## General Description

XC2V3000-4FG676I is a Field Programmable Gate Array (FPGA) device manufactured by Xilinx. Here are some of its features:

### Features

- Logic Cells: 3,000,000
- Slices: 7,200
- Block RAM: 864 Kbits
- DSP Slices: 576
- Maximum Frequency: 400 MHz
- I/O Pins: 676

### Application

- Video processing and display
- Audio processing
- High-performance computing
- Industrial control systems
- Aerospace and defense

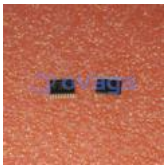


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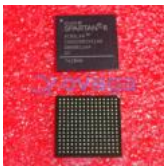
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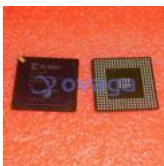
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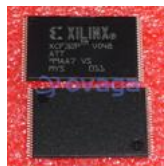
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